

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



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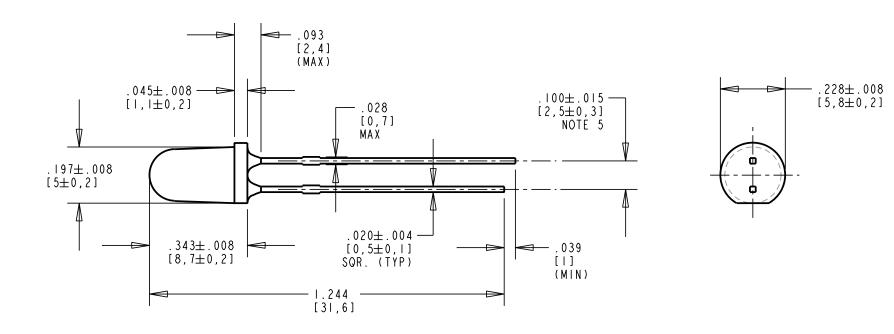




OPERATING CHARACTERISTICS AT 25° C AMBIENT

OTERATING CHARACTERISTICS AT 2.					
LED CHARACTERISTICS	MIN.	TYP.	MAX.	UNITS	TEST CONDITIONS
FORWARD VOLTAGE		2.15	2.6	٧	I _F = 20 mA
REVERSE VOLTAGE	5	20		٧	I _R = 100μA
LUMINOUS INTENSITY	1650*		6300*	mc d	I _F = 20 mA
CAPACITANCE		40		pF	V _F = 0; f=1 MHz
PEAK WAVELENGTH		594		nm	I _F = 20 mA
DOMINANT WAVELENGTH		592		nm	I _F = 20 mA
VIEWING ANGLE (2 & 1/2)		30		deg.	
SPECTRAL HALFWIDTH		17		nm	I _F = 20 mA

	ABSOLUTE MAXIMUM RATINGS AT 25° C AMBIENT		UNITS
l	PEAK FORWARD CURRENT	70	mA
	AVERAGE FORWARD CURRENT (② I PEAK = 100 mA; f≥ 1 KHz)	30	mA
ı	DC FORWARD CURRENT	50	mA
l	DERATE LINEARLY FROM 50°C	0.7	mA/°C
l	TRANSIENT FORWARD CURRENT (IOµs PULSE)	500	mA
	SOLDERING TEMPERATURE, 5 SEC., 1/16" FROM BASE	260	°C
ı	OPERATING TEMPERATURE	-40 TO +100	°C
l	STORAGE TEMPERATURE	-40 TO +120	°C



REV ECN NO

REVISIONS

NEW RELEASE

DRN CKD APP

TC

DATE

NOTES:

- I. EPOXY COLOR: CLEAR NON-DIFFUSED.
- 2. DIE: TS AlinGaP, AMBER.
- 3. SOLDER ADHERANCE: BOTH LEADS PER MIL. STD. 202E, METHOD 208C, EXCEPT STEAM AGING.
- 4. LEAD SPACING MEASURED NEAR EPOXY PACKAGE.
- 5. LEDS TO BE PACKAGED IN BULK
- 6. PACKAGE TO HAVE LABEL SHOWING DIALIGHT PART NUMBER, QTY PER BAG, DATE CODE, COUNTRY OF ORIGIN, AND INTENSITY BIN, COLOR BIN AND LOT NUMBER.
- 7. * THESE NUMBERS REFLECT 15% TOLERANCE IN BINNING. WITHOUT THE 15% TOLERANCE THE MINIMUM IS 1900cd AND MAX. 5500cd.
- 8. DIALIGHT PART NUMBER: 521-9829F
- 9. PART NUMBER WITH "F" SUFFIX ENDING IS ROHS COMPLIANT. THE BAG PACKAGING IS MARKED WITH "ROHS COMPLIANT" LABEL OR EQUIVALENT MARKINGS. PART CAN BE WAVE SOLDERED, DIP SOLDERED OR HAND SOLDERED USING TYPICAL LEAD-FREE SOLDERING PROCESS WITH MAX. 260°C TEMPERATURE FOR 5 SEC.



SCALE: DRAWING SCALE	DRAWING NUMBER	REV				
ALL DIM'S IN: INCHES (MM)		۸ ا				
TOLERANCES: UNLESS OTHERWISE SPECIFIED	C-17431	Α				
FRACTIONS: ±1/64 DECIMALS (.XX): ±.01 DECIMALS (.XXX): ±.005	TITLE LAMP					
DECIMALS (.XXXX): ±.0005 ANGLES: ±1°	MATERIAL					
FINISH:	Dialight 1501 ROUTE 3	4 SOUTH NJ 07727				
FSCM 83330	SHEET I OF I FAMILY TARIE.					

SHEET I OF I FAMILY TABLE: